

Zynq RFSoC DFE ZCU670 Evaluation Kit

OVERVIEW

Equipped with the industry's only single-chip adaptable radio device, now with hardened IP for the radio digital front-end (DFE), the Xilinx® Zynq® RFSoC DFE ZCU670 Evaluation Kit is the ideal adaptive radio prototyping platform for out-of-box evaluation and application development for 5G New Radio (5G NR) and a breadth of other RF applications.

The kit features the Zynq RFSoC DFE ZU67DR 8T8R device, representing a new class of adaptive SoCs that integrates more hardened IP than soft logic, thereby delivering the cost economies of an ASIC with the flexibility of a hardware adaptable platform. The kit comes with a breadth of connectivity options, expansion cards, software, and tools to build out and validate your system.

HIGHLIGHTS

The Only Adaptive SoC with a Fully Hardened Radio Subsystem

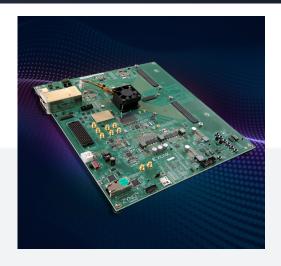
- > 8x 10GSPS DACs | 8x 2.95GSPS ADCs and 2x 5.9GSPS ADCs
- > RF input/output frequency up to 7.125GHz, 400MHz iBW
- > 3GPPP-compliant 5G NR cores: DUC, DDC, CFR, DPD, Low-PHY IP
- > Adaptive logic for differentiation and future market requirements
- > Arm® processing subsystem for DFE configuration and control

Breadth of On-Board Connectivity Options

- > 4GB DDR4, 64-bit, 2666MT/s to programmable logic (PL)
- > 4GB DDR4 SODIMM, 64-bit at 2400MT/s to processing subsystem (PS)
- > Quad SFP/SFP+ cage assembly
- > 8 user-I/O, single-color LEDs

Add-on Cards for Expansion, Rapid Prototyping, and System Validation

- > FPGA Mezzanine Card (FMC+) interface for I/O expansion
- > XM650 card for N79 band loopback test, and reference layout for baluns
- > XM755 breakout card for in-depth measurement and multi-tile sync



TARGET APPLICATIONS

5G New Radio (5G NR)

- > Massive-MIMO Macrocell
- > Multi-Mode (4G/5G) Macrocell
- > Fixed Wireless Access
- > Small Cell Nodes

Aerospace and Defense

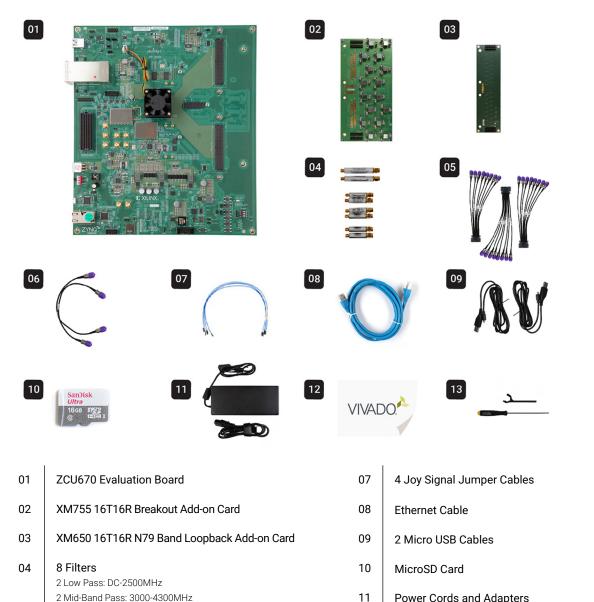
- > 5G for Government/Private Spectrum
- > Milcom and Satcom Modems
- > Data Links

Test and Measurement

- > Portable Test Equipment
- > UE Emulation/RF Testers



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TAKE THE NEXT STEP

For more information, documents, and reference designs, or to purchase, visit www.xilinx.com/zcu670

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